

MCM 2012 B Series

Specification

A decorative graphic consisting of several overlapping, semi-transparent blue and light blue geometric shapes, resembling a stylized mountain range or a series of connected planes, positioned behind the table.

Product Name	Chip Common Mode Filter
Series	MCM B Series
Size	EIAJ 2012



MCM2012B SERIES (Chip Common Mode Filter) Engineering Specification

Features and Application

- Powerful components with composite co-fired material to solve EMI problem for high speed differential signal transmission line as USB, and LVDS, without distortion to high speed signal transmission.

1.PRODUCT DETAIL

Part No.	Imp. Com. (Ω) \pm 25% @100MHz	DCR Max. (Ω)	Rated Current Max.(mA)	Rated Voltage (V)	Withstand Voltage (V)	Insulation Resistance Min.(M Ω)
MCM2012B670GBE	67	0.40	400	10	25	200
MCM2012B900GBE	90	0.40	400	10	25	200
MCM2012B121GBE	120	0.40	400	10	25	200
MCM2012B161GBE	160	0.50	400	10	25	200
MCM2012B181GBE	180	0.50	400	10	25	200
MCM2012B221FBE	220	0.50	300	10	25	200
Test Instruments	•Agilent E4991A RF IMPEDANCE / MATERIAL ANALYZER •HP4338 MILLIOHMMETER •Agilent E5071C ENA SERIES NETWORK ANALYZER •Keithley 2410 1100V SOURCE METER					

2.PART NUMBER CODE

MCM 2012 B 90 0 G B E
 1 2 3 4 5 6 7 8

- 1 Series Name
- 2 Size Code: the first two digitals : length(mm), the last two digitals : width(mm)
- 3 Material Code
- 4 Impedance(Ω) \pm 25% } (ex : 900=90 Ω ; 121=120 Ω)
- 5 Fixed Decimal Point }
- 6 Rated Current Code

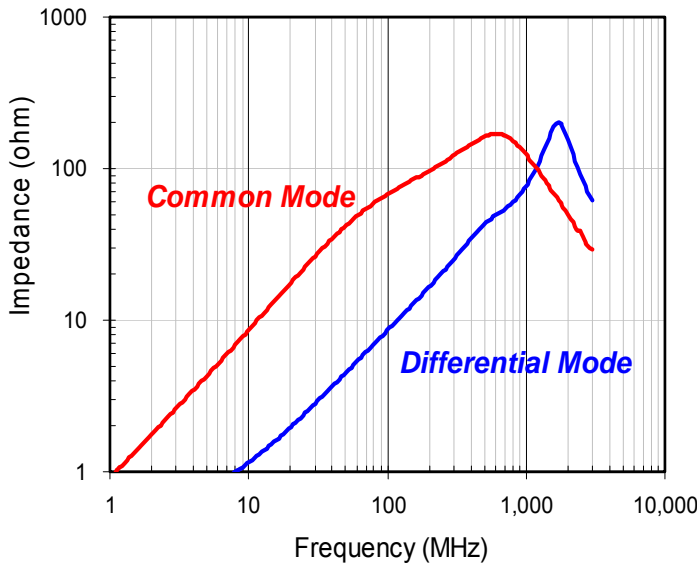
A=50mA	B=80mA	C=100mA	D=150mA	E=200mA	F=300mA
G=400mA	H=500mA	I=600mA	J=700mA	K=800mA	

- 7 Soldering: Green Parts: A— Soldering Lead-Free B— Lead-Free for whole chip
- 8 Packaging: E - Embossed plastic tape, 7" reel.

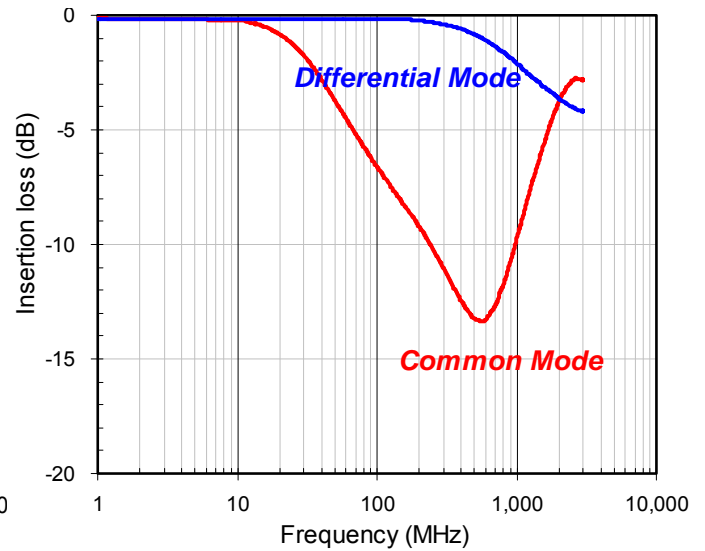
3.TYPICAL CHARACTERISTIC

MCM2012B670

IMPEDANCE vs. FREQUENCY CHARACTERISTICS

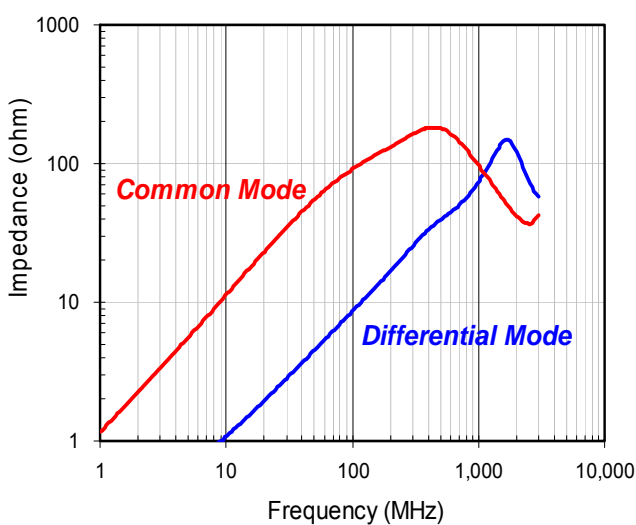


INSERTION LOSS vs. FREQUENCY CHARACTERISTICS

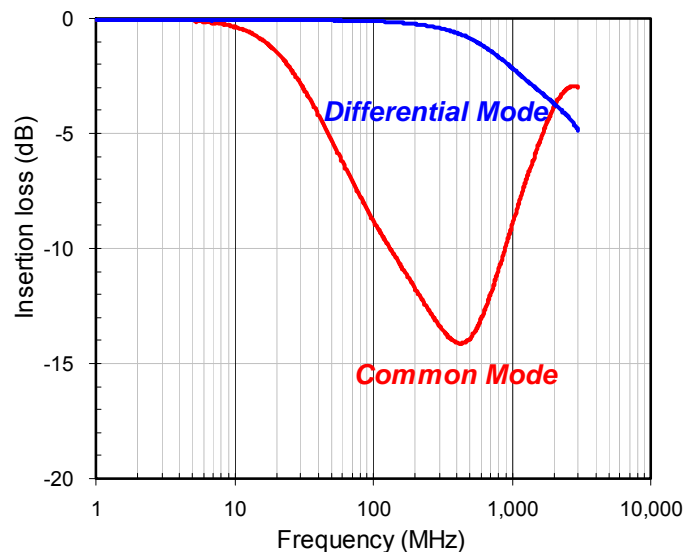


MCM2012B900

IMPEDANCE vs. FREQUENCY CHARACTERISTICS



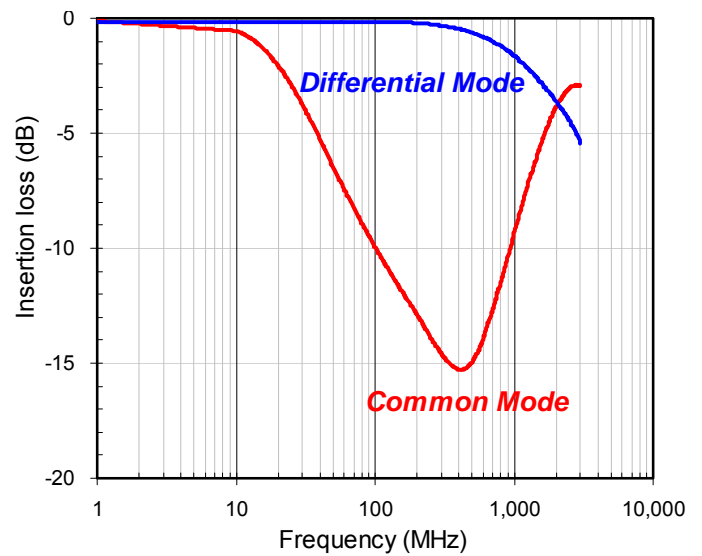
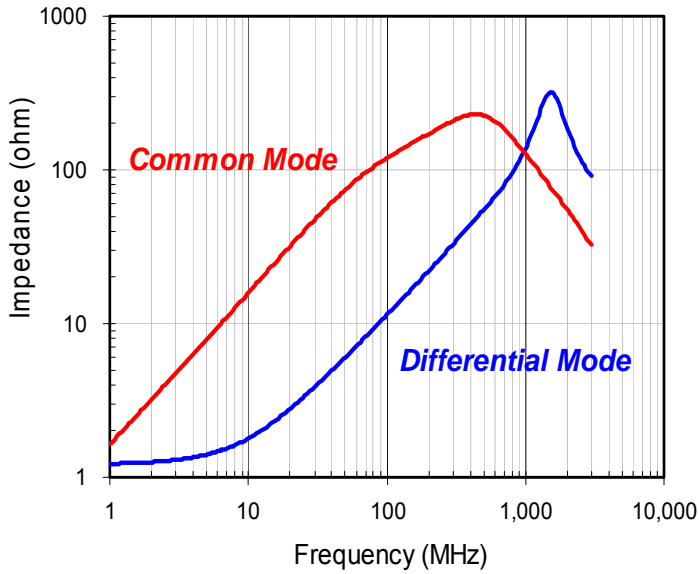
INSERTION LOSS vs. FREQUENCY CHARACTERISTICS



MCM2012B121

IMPEDANCE vs. FREQUENCY CHARACTERISTICS

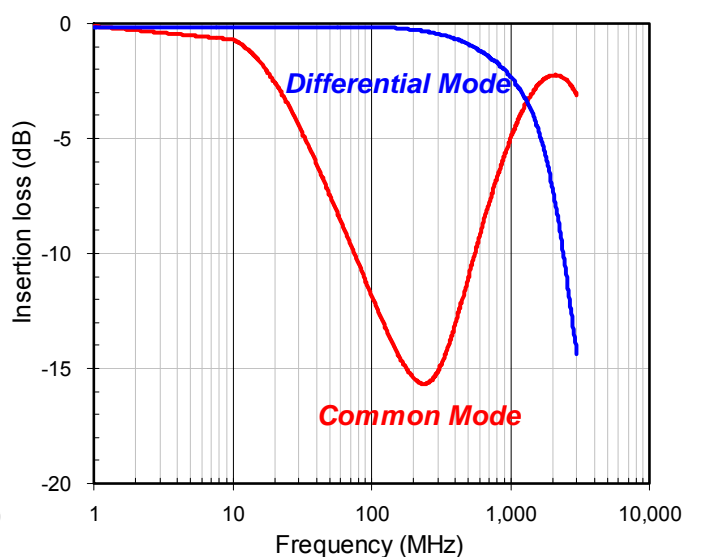
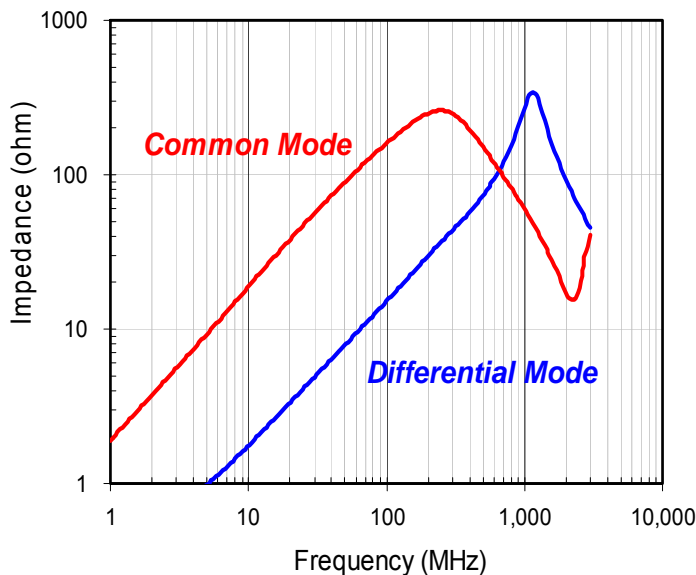
INSERTION LOSS vs. FREQUENCY CHARACTERISTICS



MCM2012B161

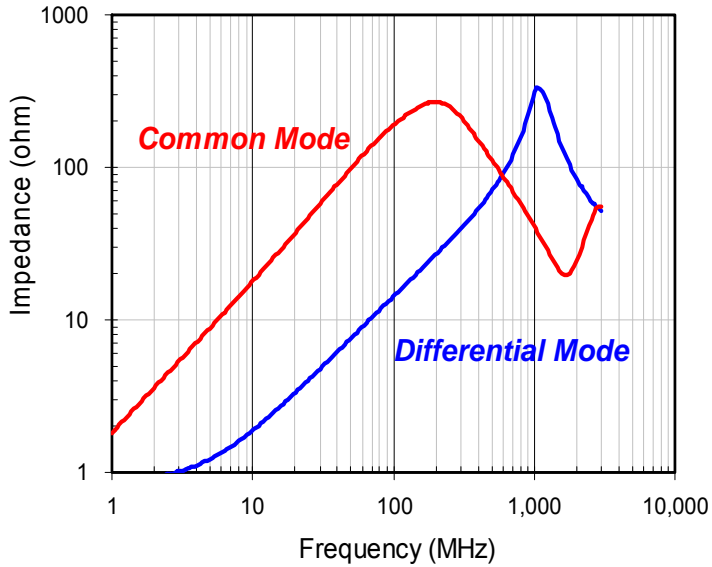
IMPEDANCE vs. FREQUENCY CHARACTERISTICS

INSERTION LOSS vs. FREQUENCY CHARACTERISTICS

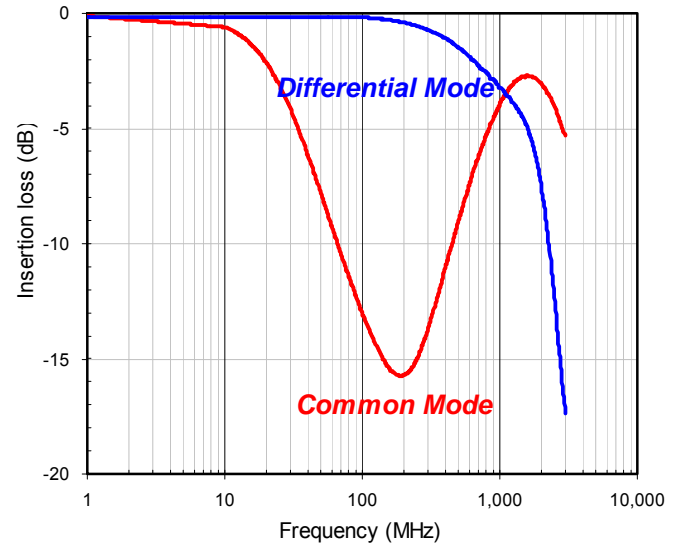


MCM2012B181

IMPEDANCE vs. FREQUENCY CHARACTERISTICS

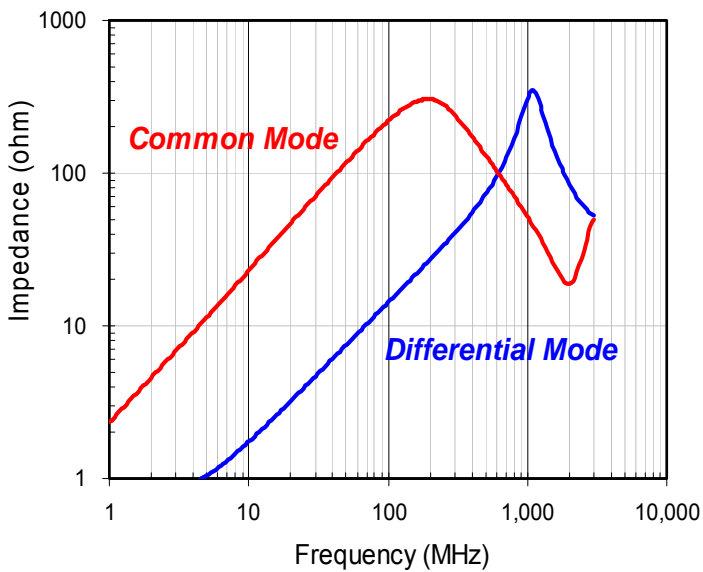


INSERTION LOSS vs. FREQUENCY CHARACTERISTICS

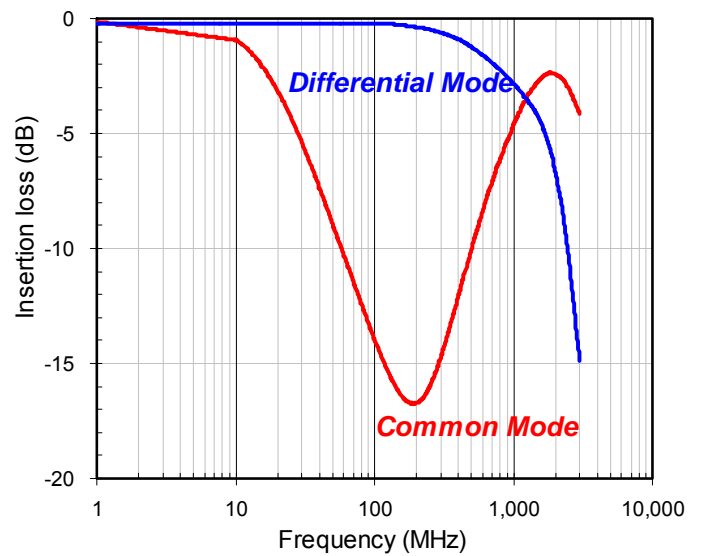


MCM2012B221

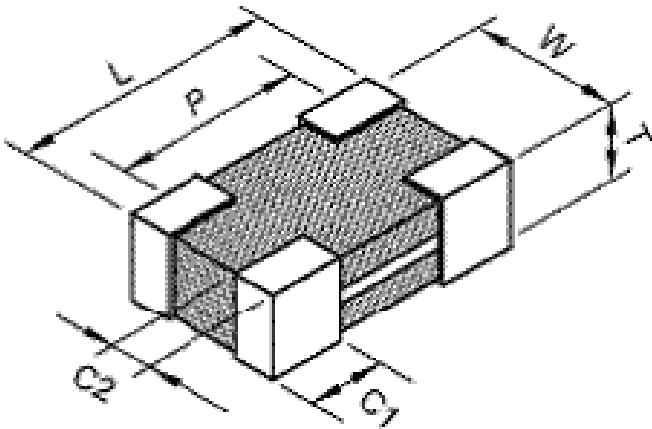
IMPEDANCE vs. FREQUENCY CHARACTERISTICS



INSERTION LOSS vs. FREQUENCY CHARACTERISTICS



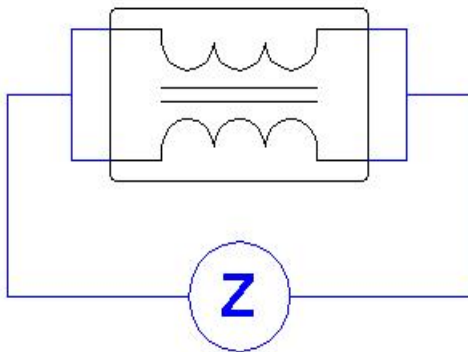
4. SHAPES AND DIMENSIONS



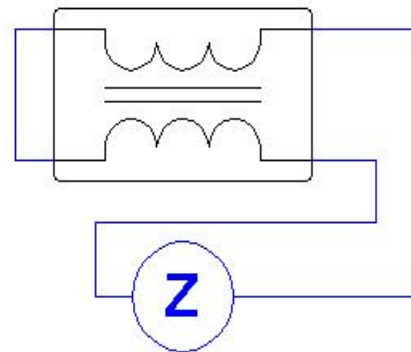
TYPE	2012
L	2.00±0.20
W	1.25±0.20
T	1.00±0.10
P	1.60±0.20
C1	0.40±0.20
C2	0.30±0.20
Unit: mm	

5. MEASURING CIRCUITS

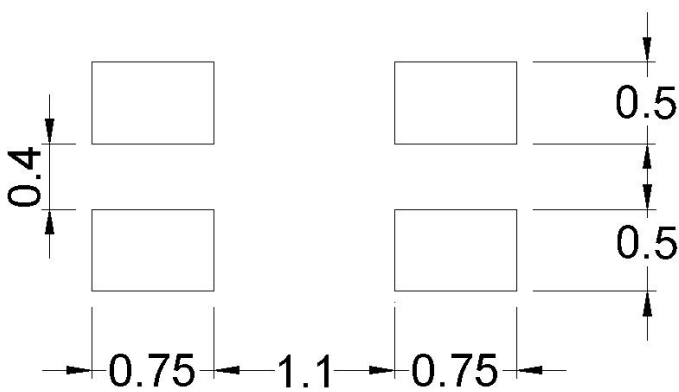
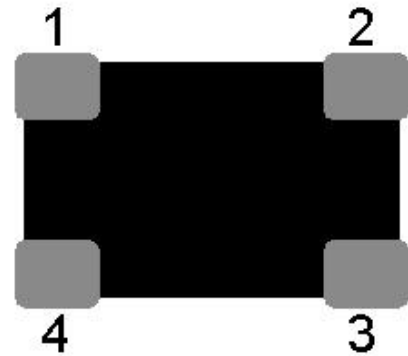
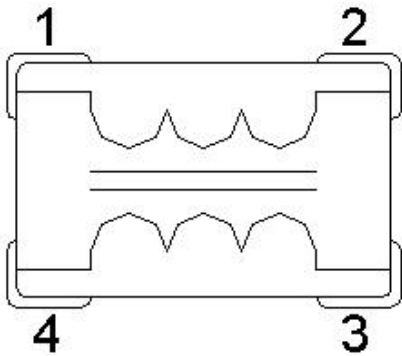
(A): Common mode



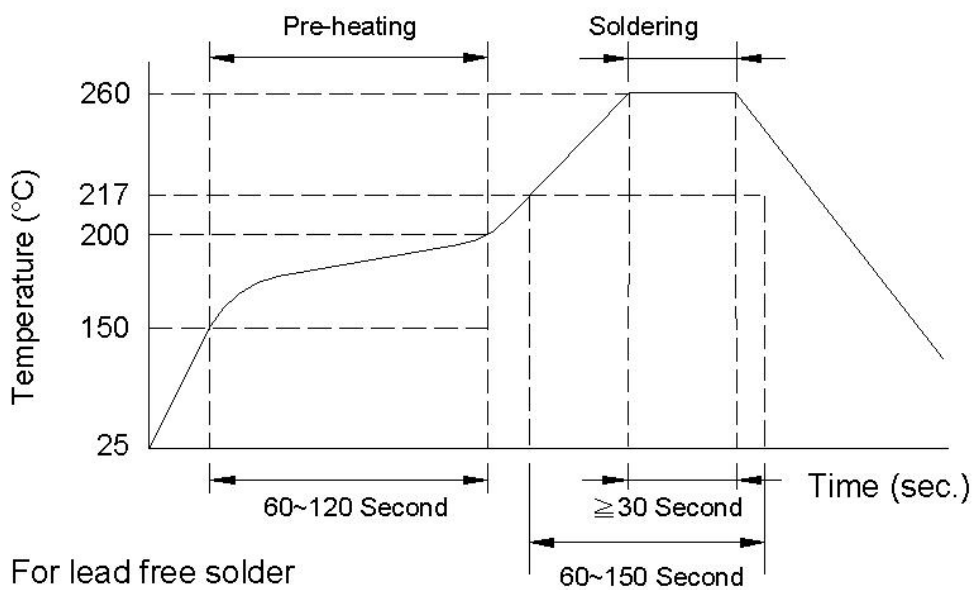
(B): Differential mode



6. CIRCUIT CONFIGURATION & LAYOUT PAD



7. RECOMMENDED SOLDERING CONDITIONS

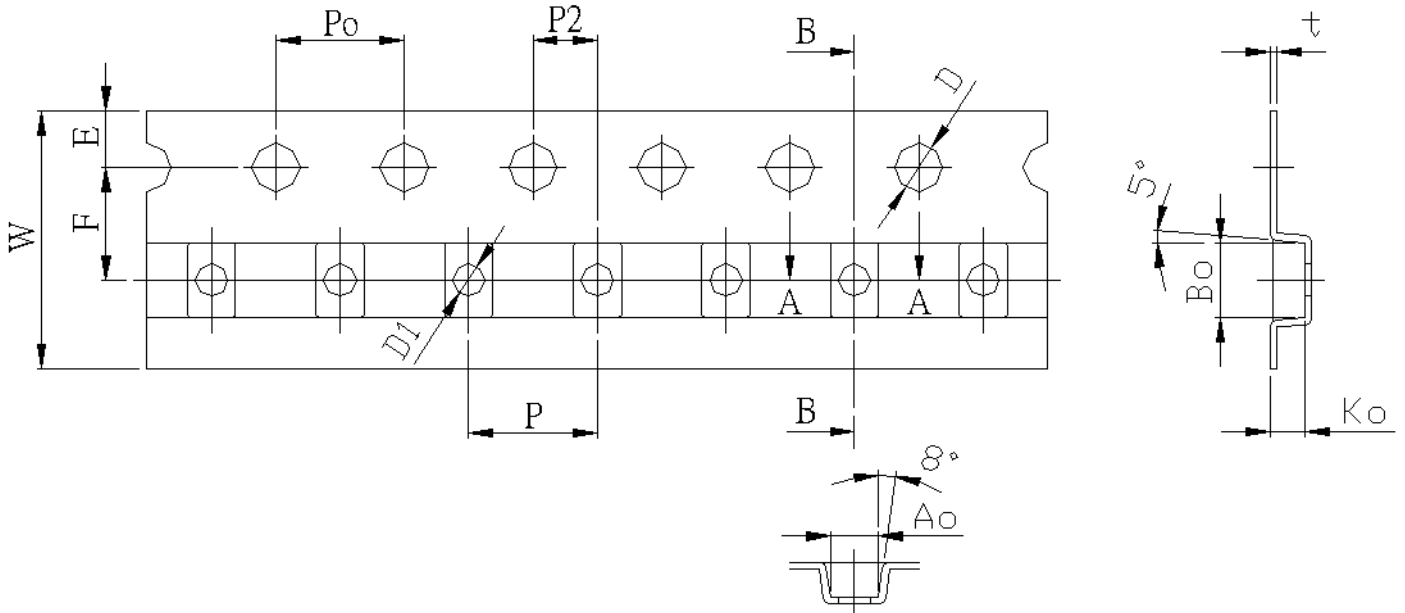


8.RELIABILITY AND TEST CONDITION

Test item	Test condition	Criteria
Temperature Cycle	A. Temperature : -40 ~ +85°C B. Cycle : 100 cycles C. Dwell time : 30minutes Measurement : at ambient temperature 24 hrs after test completion	A. No mechanical damage B. Impedance value should be within ± 20 % of the initial value
Operational Life	A. Temperature : 85°C ± 5°C B. Test time : 1000 hrs C. Apply current : full rated current Measurement : at ambient temperature 24 hrs after test completion	A. No mechanical damage B. Impedance value should be within ± 20 % of the initial value
Biased Humidity	A. Temperature : 40 ± 2°C B. Humidity : 90 ~ 95 % RH C. Test time : 1000 hrs D. Apply current : full rated current Measurement : at ambient temperature 24 hrs after test completion	A. No mechanical damage B. Impedance value should be within ± 20 % of the initial value
Resistance to Solder Heat	A. Solder temperature : 260 ± 5°C B. Flux : Rosin C. DIP time : 10 ± 1 sec	A. More than 95 % of terminal electrode should be covered with new solder B. No mechanical damage C. Impedance value should be within ± 20 % of the initial value
Steam Aging Test	A. Temperature : 93 ± 2°C B. Test time : 4 hrs(MCA) Others : 8 hrs C. Solder temperature : 235 ± 5°C D. Flux : Rosin E. DIP time : 5 ± 1 sec	More than 95 % of terminal electrode should be covered with new solder

9.TAPE AND REEL SPECIFICATIONS

Type : Plastic Carrier



Unit : mm

Symbol	Size	Symbol	Size
W	8.00 ± 0.10	D1	1.00 ± 0.10
P	4.00 ± 0.10	Po	4.00 ± 0.10
E	1.75 ± 0.10	Ao	1.40 ± 0.10
F	3.50 ± 0.05	Bo	2.30 ± 0.10
P2	2.00 ± 0.05	Ko	1.13 ± 0.10
D	$1.50^{+0.10}_{-0.00}$	t	0.22 ± 0.05

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for [Common Mode Chokes / Filters](#) category:

Click to view products by [Inpaq](#) manufacturer:

Other Similar products are found below :

[PE-64683](#) [RD5122-6-9M6](#) [ST6118T-R](#) [FE3X025-10-7NL](#) [T8114NLT](#) [TCM0806G-350-2P-T](#) [TCM0806G-650-2P-T](#) [IND-0110](#)
[UAL21VR0802000](#) [UALSC023000000](#) [UALSC1020JH000](#) [UALSU10VD20010](#) [UALSU9VD070100](#) [36-00037](#) [CM7060M132R-10](#)
[UALW21HS072450](#) [UALSU9H0208000](#) [UAL24VK06450CH](#) [PLT10HH501100PNB](#) [PLT10HH401100PNB](#) [PLT10HH1026R0PNB](#) [PE-](#)
[67531](#) [TLH10UB](#) [113 0R5](#) [2752045447](#) [CM8663Z161B-10](#) [7351V](#) [CMF16-153131](#) [T8116NLT](#) [CMS2-10-R](#) [FE2X10-4-2NL](#) [T8003NLT](#)
[CTX01-13663](#) [CTX66-19521-R](#) [RC212-0.5-10M](#) [RC112-0.4-15M](#) [RC212-0.6-6M8](#) [RC212-0.4-15M](#) [RC112-0.3-30M](#) [4534-3](#)
[WTCF2012Z0M751PB](#) [PH9408.814NLT](#) [B82498B3221J000](#) [PAC6006.364NLT](#) [PAC6006.444NLT](#) [PAC6006.204NLT](#) [PH9407.204NLT](#)
[PAC6006.264NLT](#) [PH9408.105NLT](#) [PH9408.494NLT](#) [PAC6006.104NLT](#)